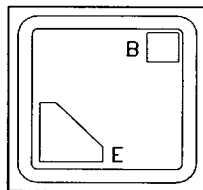


.025" NPN Phototransistor Chip**VTT-C25****E. G. & G VACTEC****DESCRIPTION**

EG&G Vactec fabricates its silicon photosensor chips using state-of-the-art planar diffusion technology. All chips are nitride passivated to ensure long term stability. Collector contact can be made through the backside of the chip. With some devices an additional collector contact is available on the top surface. Base and emitter contacts are available on the top surface of the chip.

A chromium/nickel metallization system, suitable for conductive epoxy die attach, is employed on the backside of the chip. Aluminum metallization is used for the bond pads on the top surface of the die.

Chips can be specially probed for current gain, breakdown voltage, dark current, etc., to satisfy a specific application. Please contact Vactec with your requirements.

CHIP DIMENSIONS inch (mm)**CHIP 25T**

.025 (0.64) x .025 (0.64) x .009 (0.23) Thick
 .000295 in² (0.191 mm²) Exposed Sensitive Area
 Collector Contact is Back Side of Chip

ABSOLUTE MAXIMUM RATINGS ■

Maximum Temperatures

Storage Temperature: -65°C to 150°COperating Temperature: -65°C to 125°C

Nominal Maximum Continuous

Power Dissipation @ 25°C: 50 mW *

* Exact maximum power dissipation capabilities are determined by customer packaging and are not guaranteed by Vactec.

ELECTRO-OPTICAL CHARACTERISTICS @ 25°C (See also 25T curves, pg. 15 & 16)

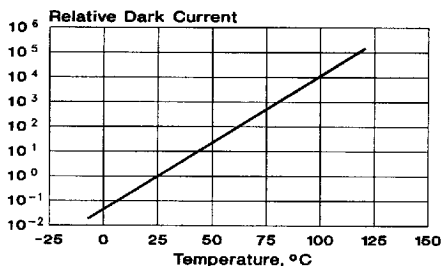
Symbol	Characteristic	Test Condition	Specification			Units
			Min.	Typ.	Max.	
H _{FE} (Beta)	dc Current Gain	I _B = 1.3 μA, V _{CE} = 5.0 V	250	500		
I _D	Dark Current	V _{CE} = 10 V, I _B = 0			100	nA
V _{BR} (CEO)	Collector Breakdown Voltage	I _C = 100 μA	30			Volts
V _{BR} (ECO)	Emitter Breakdown Voltage	I _E = 100 μA	6.0			Volts
V _{CE} (SAT)	Collector-Emitter Saturation Voltage	I _C = 1.0 mA, I _B = 50 μA			0.25	Volts
t _R , t _F	Rise / Fall Time	I _C = 1.0 mA, R _L = 100 Ω		3		μsec
S _P (CBO)	Collector-Base Photometric Sensitivity	V _{CB} = 5.0 V, 2850 K		14		nA / fc
S _R (CBO)	Collector-Base Radiometric Sensitivity	V _{CB} = 5.0 V, 940 nm		0.8		nA / (μW/cm ²)
C _J	Collector-Base Capacitance	V _{CB} = 5.0 V, 1 MHz		11		pF

25T Phototransistor Typical Characteristic Curves

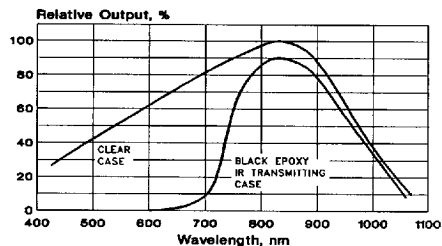
E G & G VACTEC

T-41-47

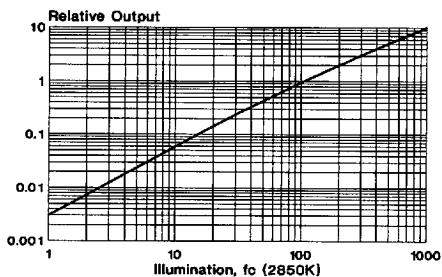
DARK CURRENT vs TEMPERATURE
(REFERRED TO 25°C)



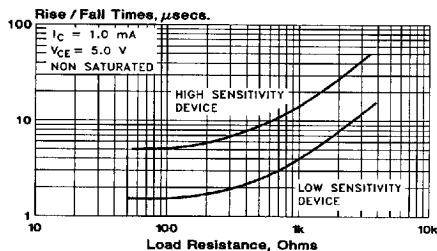
RELATIVE SPECTRAL RESPONSE
(REFERRED TO PEAK RESPONSE OF CLEAR CASE)



RELATIVE OUTPUT vs ILLUMINATION
(NORMALIZED AT 100 fc)



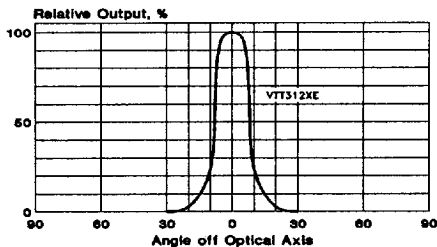
RESPONSE TIME



25T Phototransistor Typical Characteristic Curves

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**ANGULAR RESPONSE
COAX PACKAGE****ANGULAR RESPONSE
MOLDED EPOXY PACKAGES**